

TE Internal #: 5103311-9

Wire-to-Board, 44 Position, 2.54 mm [.1 in] Centerline, Right Angle,

Through Hole - Solder, 2 Row, Plug, Low Profile, Ribbon Cable

Connectors

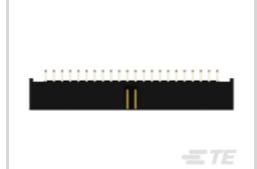
View on TE.com >

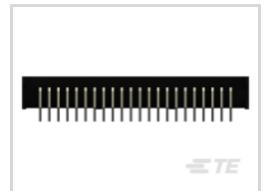


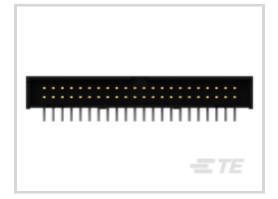
Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors











Connector System: Wire-to-Board

Number of Positions: 44

Centerline (Pitch): 2.54 mm [ .1 in ]

PCB Mount Retention: Without

PCB Mount Orientation: Right Angle

**Features** 

#### **Product Type Features**

Froduct Type reatures	
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	44
PCB Mount Orientation	Right Angle
Number of Rows	2
Body Features	
Connector Profile	Low
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
PCB Contact Termination Area Plating Material	Tin

1 A

Contact Current Rating (Max)



#### **Termination Features**

Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention	Without
Mating Alignment Type	Center, Dual Polarizing Bar
Mating Retention	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	

## **Product Compliance**

Circuit Application

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 265°C

Signal

### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products



will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts



## Customers Also Bought





















### **Documents**

### **Product Drawings**



#### A/L LOW PRO HDR 44P RA BLACK

English

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5103311-9\_B.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5103311-9\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5103311-9\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## **Product Specifications**

**Product Specification** 

English